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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

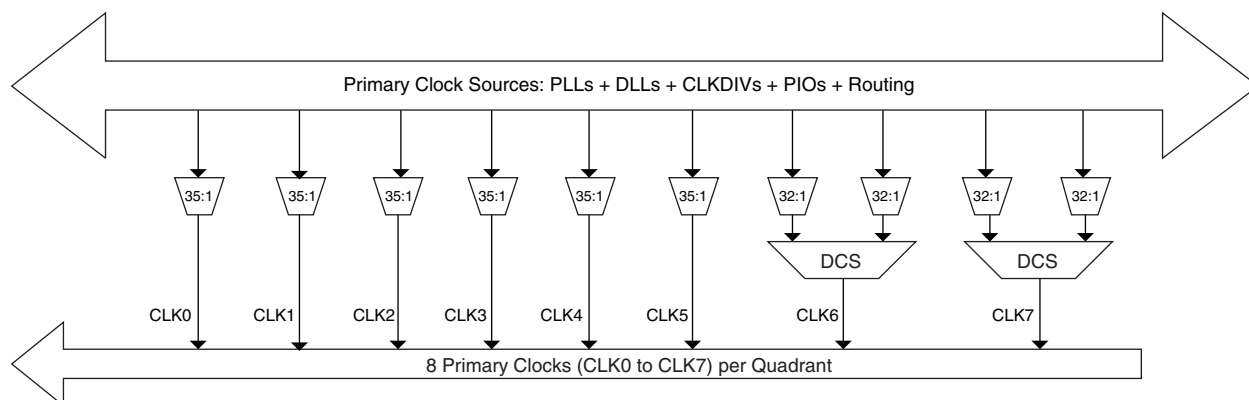
Details

Product Status	Active
Number of LABs/CLBs	4250
Number of Logic Elements/Cells	34000
Total RAM Bits	2151424
Number of I/O	410
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	672-BBGA
Supplier Device Package	672-FPBGA (27x27)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2m35e-6fn672c

Primary Clock Routing

The clock routing structure in LatticeECP2/M devices consists of a network of eight primary clock lines (CLK0 through CLK7) per quadrant. The primary clocks of each quadrant are generated from muxes located in the center of the device. All the clock sources are connected to these muxes. Figure 2-13 shows the clock routing for one quadrant. Each quadrant mux is identical. If desired, any clock can be routed globally

Figure 2-13. Per Quadrant Primary Clock Selection

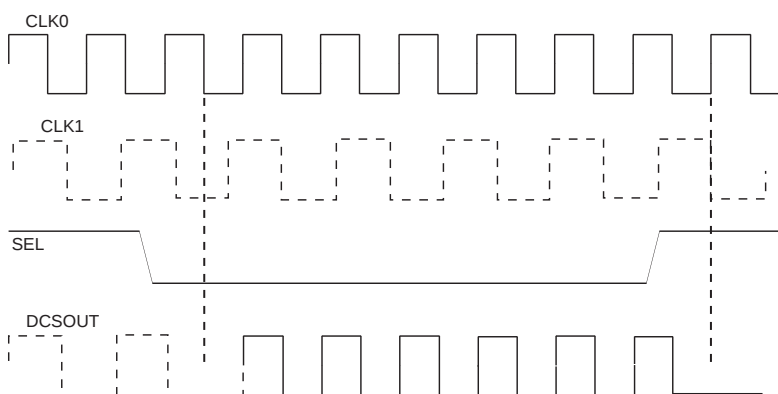


Dynamic Clock Select (DCS)

The DCS is a smart multiplexer function available in the primary clock routing. It switches between two independent input clock sources without any glitches or runt pulses. This is achieved regardless of when the select signal is toggled. There are two DCS blocks per quadrant; in total, there are eight DCS blocks per device. The inputs to the DCS block come from the center muxes. The output of the DCS is connected to primary clocks CLK6 and CLK7 (see Figure 2-13).

Figure 2-14 shows the timing waveforms of the default DCS operating mode. The DCS block can be programmed to other modes. For more information about the DCS, please see the list of additional technical documentation at the end of this data sheet.

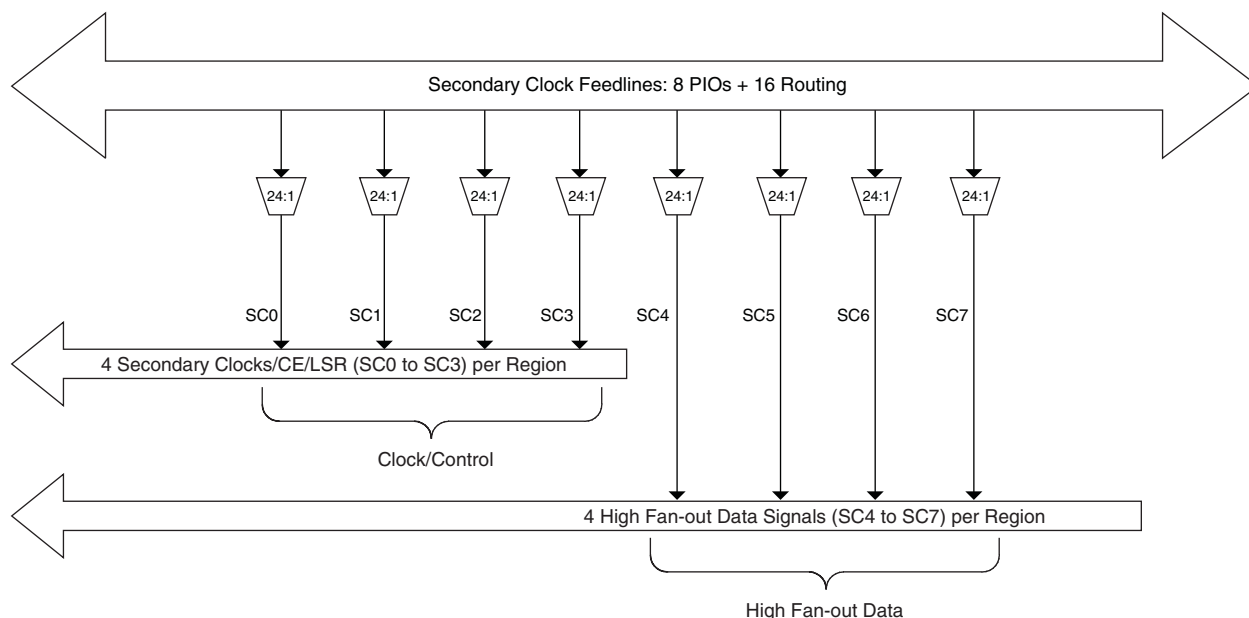
Figure 2-14. DCS Waveforms



Secondary Clock/Control Routing

Secondary clocks in the LatticeECP2 devices are region-based resources. The benefit of region-based resources is the relatively low injection delay and skew within the region, as compared to primary clocks. EBR/DSP rows and a special vertical routing channel bound the secondary clock regions. This special vertical routing channel aligns with either the left edge of the center DSP block in the DSP row or the center of the DSP row. Figure 2-15 shows

Figure 2-16. Secondary Clock Selection

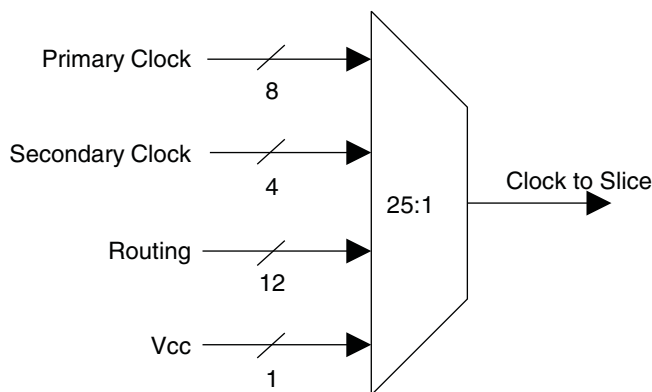


Slice Clock Selection

Figure 2-17 shows the clock selections and Figure 2-18 shows the control selections for Slice0 through Slice2. All the primary clocks and the four secondary clocks are routed to this clock selection mux. Other signals can be used as a clock input to the slices via routing. Slice controls are generated from the secondary clocks or other signals connected via routing.

If none of the signals are selected for both clock and control then the default value of the mux output is 1. Slice 3 does not have any registers; therefore it does not have the clock or control muxes.

Figure 2-17. Slice0 through Slice2 Clock Selection



If an EBR is pre-loaded during configuration, the GSR input must be disabled or the release of the GSR during device Wake Up must occur before the release of the device I/Os becomes active.

These instructions apply to all EBR RAM and ROM implementations.

Note that there are no reset restrictions if the EBR synchronous reset is used and the EBR GSR input is disabled.

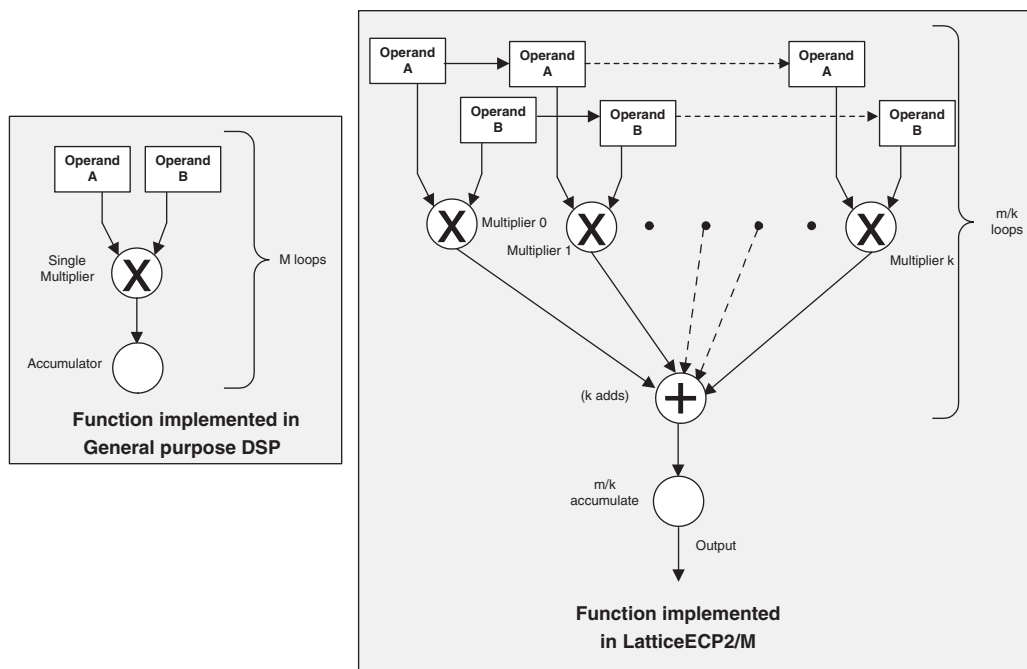
sysDSP™ Block

The LatticeECP2/M family provides a sysDSP block, making it ideally suited for low cost, high performance Digital Signal Processing (DSP) applications. Typical functions used in these applications are Finite Impulse Response (FIR) filters, Fast Fourier Transforms (FFT) functions, Correlators, Reed-Solomon/Turbo/Convolution encoders and decoders. These complex signal processing functions use similar building blocks such as multiply-adders and multiply-accumulators.

sysDSP Block Approach Compared to General DSP

Conventional general-purpose DSP chips typically contain one to four (Multiply and Accumulate) MAC units with fixed data-width multipliers; this leads to limited parallelism and limited throughput. Their throughput is increased by higher clock speeds. The LatticeECP2/M, on the other hand, has many DSP blocks that support different data-widths. This allows the designer to use highly parallel implementations of DSP functions. The designer can optimize the DSP performance vs. area by choosing an appropriate level of parallelism. Figure 2-22 compares the fully serial and the mixed parallel and serial implementations.

Figure 2-22. Comparison of General DSP and LatticeECP2/M Approaches



sysDSP Block Capabilities

The sysDSP block in the LatticeECP2/M family supports four functional elements in three 9, 18 and 36 data path widths. The user selects a function element for a DSP block and then selects the width and type (signed/unsigned) of its operands. The operands in the LatticeECP2/M family sysDSP Blocks can be either signed or unsigned but not mixed within a function element. Similarly, the operand widths cannot be mixed within a block. In the LatticeECP2/M family the DSP elements can be concatenated.

The resources in each sysDSP block can be configured to support the following elements:

Figure 3-6. SPI4.2 Parameters

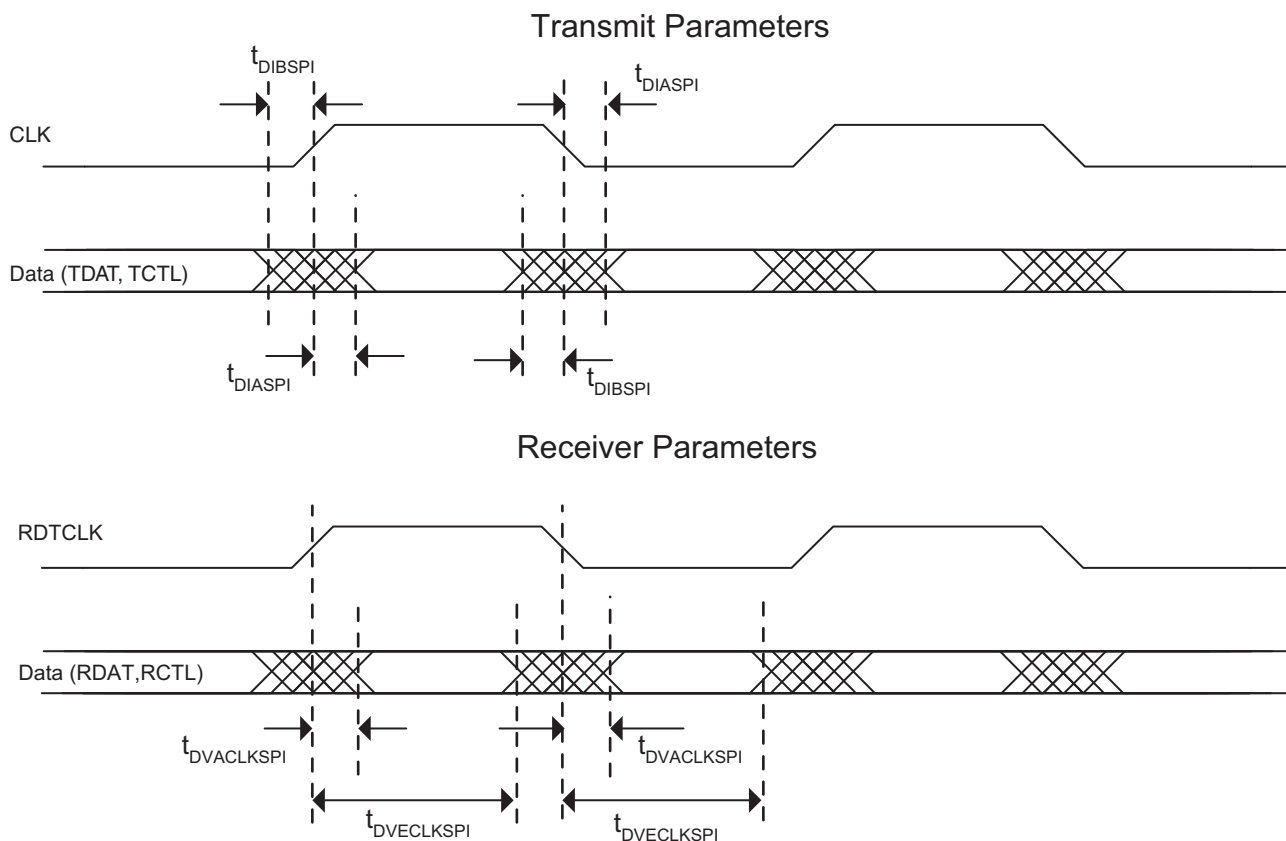


Figure 3-7. DDR and DDR2 Parameters

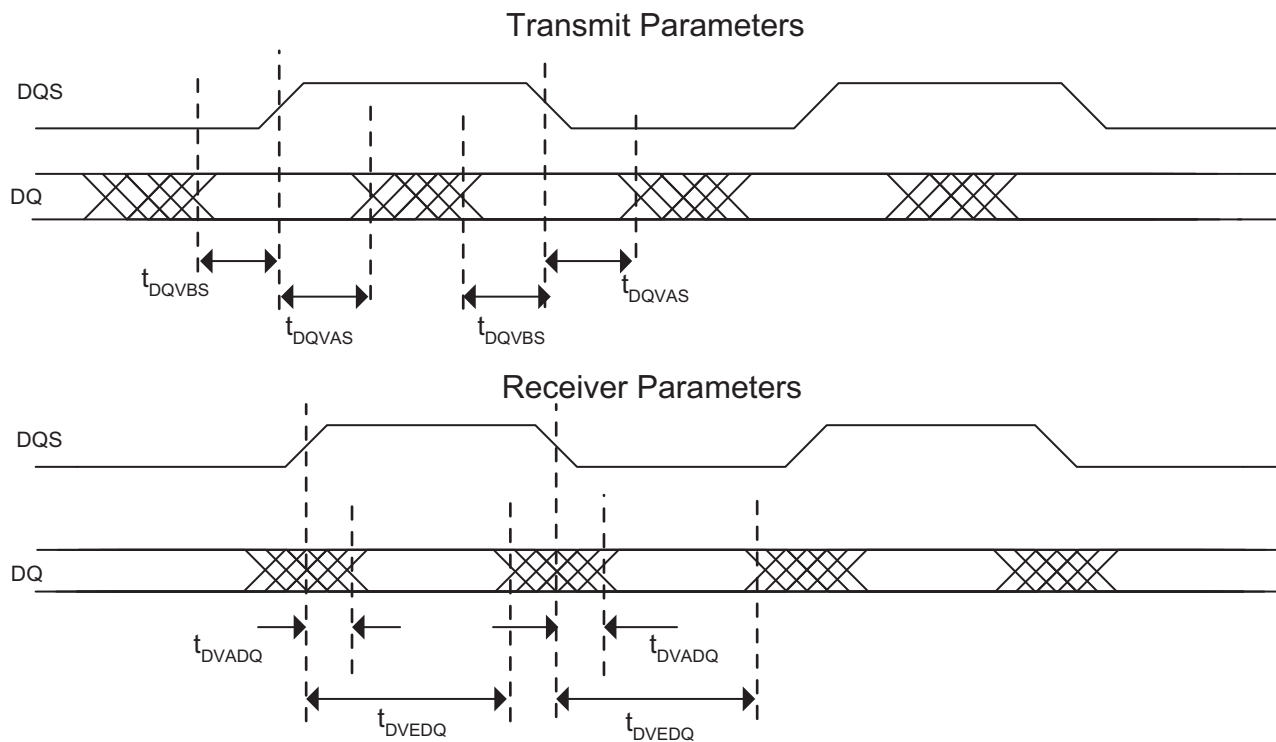
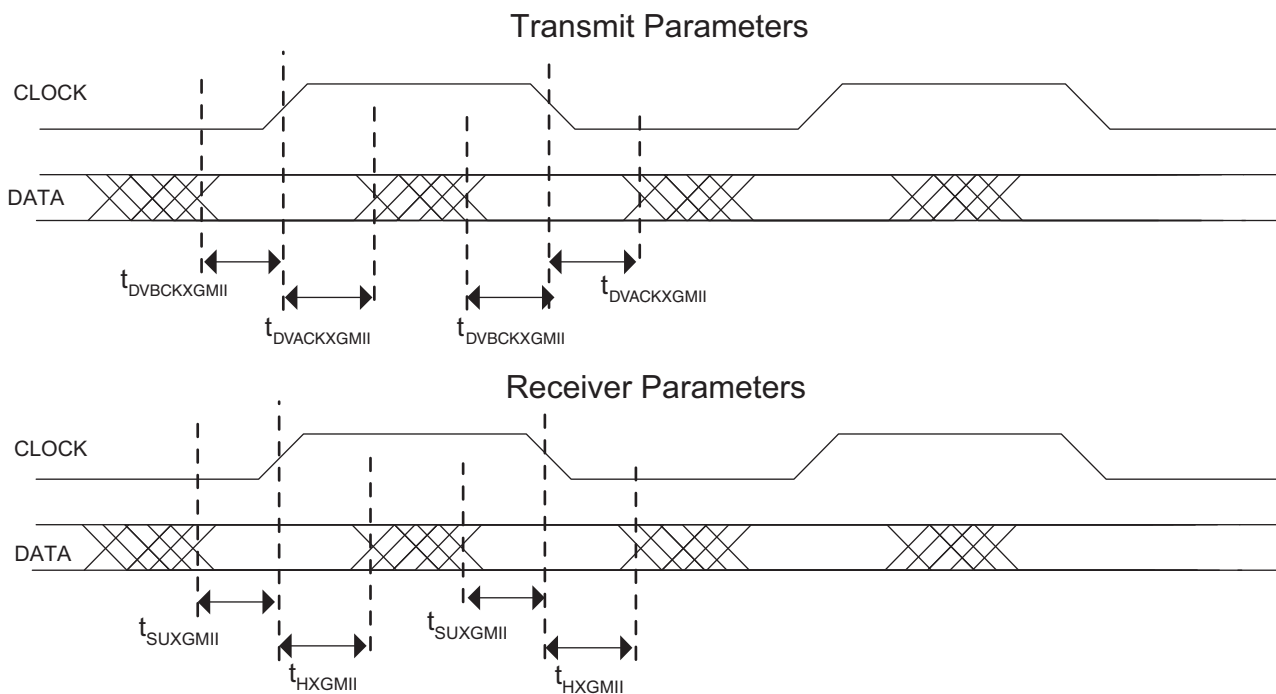


Figure 3-8. XGMII Parameters



LatticeECP2/M Family Timing Adders^{1, 2, 3}
Over Recommended Operating Conditions

Buffer Type	Description	-7	-6	-5	Units
Input Adjusters					
LVDS25	LVDS	-0.04	-0.02	0.00	ns
BLVDS25	BLVDS	-0.04	-0.09	-0.15	ns
MLVDS	LVDS	-0.15	-0.15	-0.15	ns
RSDS	RSDS	-0.15	-0.15	-0.15	ns
LVPECL33	LVPECL	0.16	0.15	0.13	ns
HSTL18_I	HSTL_18 class I	0.01	-0.01	-0.04	ns
HSTL18_II	HSTL_18 class II	0.01	-0.01	-0.04	ns
HSTL18D_I	Differential HSTL 18 class I	0.01	-0.01	-0.04	ns
HSTL18D_II	Differential HSTL 18 class II	0.01	-0.01	-0.04	ns
HSTL15_I	HSTL_15 class I	0.01	-0.01	-0.04	ns
HSTL15D_I	Differential HSTL 15 class I	0.01	-0.01	-0.04	ns
SSTL33_I	SSTL_3 class I	-0.03	-0.07	-0.10	ns
SSTL33_II	SSTL_3 class II	-0.03	-0.07	-0.10	ns
SSTL33D_I	Differential SSTL_3 class I	-0.03	-0.07	-0.10	ns
SSTL33D_II	Differential SSTL_3 class II	-0.03	-0.07	-0.10	ns
SSTL25_I	SSTL_2 class I	-0.04	-0.07	-0.10	ns
SSTL25_II	SSTL_2 class II	-0.04	-0.07	-0.10	ns
SSTL25D_I	Differential SSTL_2 class I	-0.04	-0.07	-0.10	ns
SSTL25D_II	Differential SSTL_2 class II	-0.04	-0.07	-0.10	ns
SSTL18_I	SSTL_18 class I	-0.01	-0.04	-0.07	ns
SSTL18_II	SSTL_18 class II	-0.01	-0.04	-0.07	ns
SSTL18D_I	Differential SSTL_18 class I	-0.01	-0.04	-0.07	ns
SSTL18D_II	Differential SSTL_18 class II	-0.01	-0.04	-0.07	ns
LVTTTL33	LVTTTL	-0.16	-0.16	-0.16	ns
LVC MOS33	LVC MOS 3.3	-0.08	-0.12	-0.16	ns
LVC MOS25	LVC MOS 2.5	0.00	0.00	0.00	ns
LVC MOS18	LVC MOS 1.8	-0.16	-0.17	-0.17	ns
LVC MOS15	LVC MOS 1.5	-0.14	-0.14	-0.14	ns
LVC MOS12	LVC MOS 1.2	-0.04	-0.01	0.01	ns
PCI33	PCI	-0.08	-0.12	-0.16	ns
Output Adjusters					
LVDS25E	LVDS 2.5 E ⁴	0.25	0.19	0.13	ns
LVDS25	LVDS 2.5	0.10	0.13	0.17	ns
BLVDS25	BLVDS 2.5	0.00	-0.01	-0.03	ns
MLVDS	MLVDS 2.5 ⁴	0.00	-0.01	-0.03	ns
RSDS	RSDS 2.5 ⁴	0.25	0.19	0.13	ns
LVPECL33	LVPECL 3.3 ⁴	-0.02	-0.04	-0.06	ns
HSTL18_I	HSTL_18 class I 8mA drive	-0.19	-0.22	-0.25	ns
HSTL18_II	HSTL_18 class II	-0.30	-0.34	-0.37	ns
HSTL18D_I	Differential HSTL 18 class I 8mA drive	-0.19	-0.22	-0.25	ns
HSTL18D_II	Differential HSTL 18 class II	-0.30	-0.34	-0.37	ns

Signal Descriptions (Cont.)

Signal Name	I/O	Description
[LOC]DQS[num]	I/O	DQ input/output pads: T (top), R (right), B (bottom), L (left), DQS, num = ball function number.
[LOC]DQ[num]	I/O	DQ input/output pads: T (top), R (right), B (bottom), L (left), DQ, associated DQS number.
Test and Programming (Dedicated Pins)		
TMS	I	Test Mode Select input, used to control the 1149.1 state machine. Pull-up is enabled during configuration.
TCK	I	Test Clock input pin, used to clock the 1149.1 state machine. No pull-up enabled.
TDI	I	Test Data in pin. Used to load data into device using 1149.1 state machine. After power-up, this TAP port can be activated for configuration by sending appropriate command. (Note: once a configuration port is selected it is locked. Another configuration port cannot be selected until the power-up sequence). Pull-up is enabled during configuration.
TDO	O	Output pin. Test Data Out pin used to shift data out of a device using 1149.1.
VCCJ	—	Power supply pin for JTAG Test Access Port.
Configuration Pads (Used During sysCONFIG)		
CFG[2:0]	I	Mode pins used to specify configuration mode values latched on rising edge of INITN. During configuration, a pull-up is enabled. These are dedicated pins.
INITN	I/O	Open Drain pin. Indicates the FPGA is ready to be configured. During configuration, a pull-up is enabled. It is a dedicated pin.
PROGRAMN	I	Initiates configuration sequence when asserted low. This pin always has an active pull-up. This is a dedicated pin.
DONE	I/O	Open Drain pin. Indicates that the configuration sequence is complete, and the startup sequence is in progress. This is a dedicated pin.
CCLK	I/O	Configuration Clock for configuring an FPGA in sysCONFIG mode.
BUSY/SISPI	I/O	Read control command in SPI or SPIm mode.
CSN	I	sysCONFIG chip select (active low). During configuration, a pull-up is enabled.
CS1N	I	sysCONFIG chip select (active low). During configuration, a pull-up is enabled.
WRITEN	I	Write Data on Parallel port (active low).
D[0]/SPIFASTN	I/O	sysCONFIG Port Data I/O for Parallel mode. sysCONFIG Port Data I/O for SPI or SPIm. When using the SPI or SPIm mode, this pin should either be tied high or low, must not be left floating.
D[1:6]	I/O	sysCONFIG Port Data I/O for Parallel
D[7]/SPID0	I/O	sysCONFIG Port Data I/O for Parallel, SPI, SPIm
DOUT/CSO	O	Output for serial configuration data (rising edge of CCLK) when using sysCONFIG port.
DI/CSSPI0N	I/O	Input for serial configuration data (clocked with CCLK) when using sysCONFIG port. During configuration, a pull-up is enabled. Output when used in SPI/SPIm modes.
Dedicated SERDES Signals^{1, 2, 3}		
[LOC]_SQ_VCCAUX33	—	Termination resistor switching power (3.3V). This pin must be tied to 3.3V even if the quad is unused.
[LOC]_SQ_REFCLKN	I	Negative Reference Clock Input
[LOC]_SQ_REFCLKP	I	Positive Reference Clock Input
[LOC]_SQ_VCCP	—	PLL and Reference clock buffer power (1.2V). This pin must be tied to 1.2V even if the quad is unused.

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 208 PQFP (Cont.)

LFE2-12E/SE					LFE2-20E/SE				
Pin Number	Pin/Pad Function	Bank	Dual Function	Differential	Pin/Pad Function	Bank	Dual Function	Differential	
138	PR15A	3	PCLKT3_0	T (LVDS)*	PR21A	3	PCLKT3_0/RDQ25	T (LVDS)*	
139	GND	-			GND	-			
140	VCC	-			VCC	-			
141	PR13B	2	PCLKC2_0/RDQ10	C	PR19B	2	PCLKC2_0/RDQ16	C	
142	PR13A	2	PCLKT2_0/RDQ10	T	PR19A	2	PCLKT2_0/RDQ16	T	
143	VCCIO2	2			VCCIO2	2			
144	PR12A	2	RDQ10		PR16A	2	RDQS16		
145	GND	-			GND	-			
146	VCC	-			VCC	-			
147	PR8B	2	RDQ10	C (LVDS)*	PR14B	2	RDQ16	C (LVDS)*	
148	VCCIO2	2			VCCIO2	2			
149	PR8A	2	RDQ10	T (LVDS)*	PR14A	2	RDQ16	T (LVDS)*	
150	PR6B	2	RDQ10	C (LVDS)*	PR12B	2	RDQ16	C (LVDS)*	
151	VCCAUX	-			VCCAUX	-			
152	PR6A	2	RDQ10	T (LVDS)*	PR12A	2	RDQ16	T (LVDS)*	
153	PR4B	2		C (LVDS)*	PR6B	2	RDQ8	C (LVDS)*	
154	PR4A	2		T (LVDS)*	PR6A	2	RDQ8	T (LVDS)*	
155	PR2B	2	VREF2_2	C (LVDS)*	PR2B	2	VREF2_2	C (LVDS)*	
156	PR2A	2	VREF1_2	T (LVDS)*	PR2A	2	VREF1_2	T (LVDS)*	
157	PT55B	1	VREF2_1	C	PT64B	1	VREF2_1	C	
158	PT55A	1	VREF1_1	T	PT64A	1	VREF1_1	T	
159	GND	-			GND	-			
160	PT54B	1		C	PT62B	1		C	
161	PT54A	1		T	PT62A	1		T	
162	VCCIO1	1			VCCIO1	1			
163	PT52B	1		C	PT60B	1		C	
164	PT52A	1		T	PT60A	1		T	
165	PT50B	1		C	PT58B	1		C	
166	PT50A	1		T	PT58A	1		T	
167	PT48B	1		C	PT56B	1		C	
168	PT48A	1		T	PT56A	1		T	
169	GND	-			GND	-			
170	VCCIO1	1			VCCIO1	1			
171	VCC	-			VCC	-			
172	PT40B	1		C	PT50B	1		C	
173	PT40A	1		T	PT50A	1		T	
174	VCCAUX	-			VCCAUX	-			
175	GND	-			GND	-			
176	PT36B	1		C	PT44B	1		C	
177	PT36A	1		T	PT44A	1		T	
178	PT34B	1		C	PT42B	1		C	
179	PT34A	1		T	PT42A	1		T	
180	PT30B	1	PCLKC1_0	C	PT39B	1	PCLKC1_0	C	
181	PT30A	1	PCLKT1_0	T	PT39A	1	PCLKT1_0	T	
182	XRES	1			XRES	1			
183	PT28B	0	PCLKC0_0	C	PT37B	0	PCLKC0_0	C	

LFE2-6E/SE and LFE2-12E/SE Logic Signal Connections: 256 fpBGA

LFE2-6E/SE					LFE2-12E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
C3	PL2A	7	VREF2_7	T (LVDS)*	PL2A	7	VREF2_7	T (LVDS)*	
C2	PL2B	7	VREF1_7	C (LVDS)*	PL2B	7	VREF1_7	C (LVDS)*	
VCCIO	VCCIO7	7			VCCIO7	7			
-	-	-			-	-			
D3	PL5A	7		T	PL5A	7		T	
D4	PL4A	7		T (LVDS)*	PL4A	7		T (LVDS)*	
D2	PL5B	7		C	PL5B	7		C	
GND	GNDIO7	-			GNDIO7	-			
E4	PL4B	7		C (LVDS)*	PL4B	7		C (LVDS)*	
B1	PL7A	7	LDQ10	T	PL7A	7	LDQ10	T	
C1	PL7B	7	LDQ10	C	PL7B	7	LDQ10	C	
F5	PL9A	7	LDQ10	T	PL9A	7	LDQ10	T	
VCCIO	VCCIO7	7			VCCIO7	7			
F4	PL8A	7	LDQ10	T (LVDS)*	PL8A	7	LDQ10	T (LVDS)*	
G6	PL9B	7	LDQ10	C	PL9B	7	LDQ10	C	
G4	PL8B	7	LDQ10	C (LVDS)*	PL8B	7	LDQ10	C (LVDS)*	
D1	PL10A	7	LDQS10	T (LVDS)*	PL10A	7	LDQS10	T (LVDS)*	
GND	GNDIO7	-			GNDIO7	-			
E1	PL10B	7	LDQ10	C (LVDS)*	PL10B	7	LDQ10	C (LVDS)*	
F3	PL11A	7	LDQ10	T	PL11A	7	LDQ10	T	
G3	PL11B	7	LDQ10	C	PL11B	7	LDQ10	C	
VCCIO	VCCIO7	7			VCCIO7	7			
F2	PL12A	7	LDQ10	T (LVDS)*	PL12A	7	LDQ10	T (LVDS)*	
F1	PL12B	7	LDQ10	C (LVDS)*	PL12B	7	LDQ10	C (LVDS)*	
GND	GNDIO7	-			GNDIO7	-			
G2	PL13A	7	PCLKT7_0/LDQ10	T	PL13A	7	PCLKT7_0/LDQ10	T	
G1	PL13B	7	PCLKC7_0/LDQ10	C	PL13B	7	PCLKC7_0/LDQ10	C	
H6	PL15A	6	PCLKT6_0	T (LVDS)*	PL15A	6	PCLKT6_0	T (LVDS)*	
VCCIO	VCCIO6	6			VCCIO6	6			
H5	PL15B	6	PCLKC6_0	C (LVDS)*	PL15B	6	PCLKC6_0	C (LVDS)*	
H4	PL16A	6	VREF2_6	T	PL16A	6	VREF2_6	T	
GND	GNDIO6	-			GNDIO6	-			
H3	PL16B	6	VREF1_6	C	PL16B	6	VREF1_6	C	
H2	PL17A	6	LLM0_GDLLT_IN_A**	T (LVDS)*	PL17A	6	LLM0_GDLLT_IN_A**	T (LVDS)*	
H1	PL17B	6	LLM0_GDLLC_IN_A**	C (LVDS)*	PL17B	6	LLM0_GDLLC_IN_A**	C (LVDS)*	
G10	VCC	-			VCC	-			
J4	PL18A	6	LLM0_GDLLT_FB_A	T	PL18A	6	LLM0_GDLLT_FB_A	T	
J5	PL18B	6	LLM0_GDLLC_FB_A	C	PL18B	6	LLM0_GDLLC_FB_A	C	
J6	LLM0_PLLCAP	6			LLM0_PLLCAP	6			
K4	PL20A	6	LLM0_GPLLT_IN_A**	T (LVDS)*	PL20A	6	LLM0_GPLLT_IN_A**	T (LVDS)*	
GND	GNDIO6	-			GNDIO6	-			
J1	PL21A	6	LLM0_GPLLT_FB_A	T	PL21A	6	LLM0_GPLLT_FB_A	T	
K3	PL20B	6	LLM0_GPLLC_IN_A**	C (LVDS)*	PL20B	6	LLM0_GPLLC_IN_A**	C (LVDS)*	
VCCIO	VCCIO6	6			VCCIO6	6			
J2	PL21B	6	LLM0_GPLLC_FB_A	C	PL21B	6	LLM0_GPLLC_FB_A	C	

LFE2-6E/SE and LFE2-12E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2-6E/SE					LFE2-12E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
N14	CFG1	8			CFG1	8		
N13	PROGRAMN	8			PROGRAMN	8		
N15	CFG0	8			CFG0	8		
P15	PR30B	8	WRITEN	C	PR30B	8	WRITEN	C
L12	INITN	8			INITN	8		
N16	PR29B	8	CSN	C	PR29B	8	CSN	C
GND	GNDIO8	-			GNDIO8	-		
R14	CCLK	8			CCLK	8		
P14	PR30A	8	CS1N	T	PR30A	8	CS1N	T
M13	DONE	8			DONE	8		
R16	PR28B	8	D1	C	PR28B	8	D1	C
VCCIO	VCCIO8	8			VCCIO8	8		
M16	PR29A	8	D0/SPIFASTN	T	PR29A	8	D0/SPIFASTN	T
P16	PR28A	8	D2	T	PR28A	8	D2	T
L15	PR27B	8	D3	C	PR27B	8	D3	C
GND	GNDIO8	-			GNDIO8	-		
L14	PR26A	8	D6	T	PR26A	8	D6	T
L16	PR27A	8	D4	T	PR27A	8	D4	T
L10	PR25B	8	D7/SPID0	C	PR25B	8	D7/SPID0	C
L13	PR26B	8	D5	C	PR26B	8	D5	C
VCCIO	VCCIO8	8			VCCIO8	8		
K11	PR25A	8	DI/CSSPI0N	T	PR25A	8	DI/CSSPI0N	T
K14	PR24B	8	DOU/CSON	C	PR24B	8	DOU/CSON	C
K13	PR24A	8	BUSY/SISPI	T	PR24A	8	BUSY/SISPI	T
GND	GNDIO8	-			GNDIO8	-		
K15	PR21B	3	RLM0_GPLL_C_FB_A	C	PR21B	3	RLM0_GPLL_C_FB_A	C
VCCIO	VCCIO3	3			VCCIO3	3		
K16	PR21A	3	RLM0_GPLL_T_FB_A	T	PR21A	3	RLM0_GPLL_T_FB_A	T
GND	GNDIO3	-			GNDIO3	-		
J16	PR20B	3	RLM0_GPLL_C_IN_A**	C (LVDS)*	PR20B	3	RLM0_GPLL_C_IN_A**	C (LVDS)*
J15	PR20A	3	RLM0_GPLL_T_IN_A**	T (LVDS)*	PR20A	3	RLM0_GPLL_T_IN_A**	T (LVDS)*
J14	RLM0_PLLCAP	3			RLM0_PLLCAP	3		
J13	PR18B	3	RLM0_GDLL_C_FB_A	C	PR18B	3	RLM0_GDLL_C_FB_A	C
J12	PR18A	3	RLM0_GDLL_T_FB_A	T	PR18A	3	RLM0_GDLL_T_FB_A	T
H12	PR17B	3	RLM0_GDLL_C_IN_A**	C (LVDS)*	PR17B	3	RLM0_GDLL_C_IN_A**	C (LVDS)*
GND	GNDIO3	-			GNDIO3	-		
H13	PR17A	3	RLM0_GDLL_T_IN_A**	T (LVDS)*	PR17A	3	RLM0_GDLL_T_IN_A**	T (LVDS)*
H15	PR16B	3	VREF2_3	C	PR16B	3	VREF2_3	C
VCCIO	VCCIO3	3			VCCIO3	3		
H16	PR16A	3	VREF1_3	T	PR16A	3	VREF1_3	T
H11	PR15B	3	PCLKC3_0	C (LVDS)*	PR15B	3	PCLKC3_0	C (LVDS)*
J11	PR15A	3	PCLKT3_0	T (LVDS)*	PR15A	3	PCLKT3_0	T (LVDS)*
G16	PR13B	2	PCLKC2_0/RDQ10	C	PR13B	2	PCLKC2_0/RDQ10	C
GND	GNDIO2	-			GNDIO2	-		
G15	PR13A	2	PCLKT2_0/RDQ10	T	PR13A	2	PCLKT2_0/RDQ10	T

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-50E/SE					LFE2-70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
GND	GNDIO2	-			GNDIO2	-		
L21	PR43B	2	RDQ41	C (LVDS)*	PR56B	2	RDQ54	C (LVDS)*
K22	PR43A	2	RDQ41	T (LVDS)*	PR56A	2	RDQ54	T (LVDS)*
M24	PR42B	2	RDQ41	C	PR55B	2	RDQ54	C
N23	PR42A	2	RDQ41	T	PR55A	2	RDQ54	T
VCCIO	VCCIO2	2			VCCIO2	2		
K26	PR41B	2	RDQ41	C (LVDS)*	PR54B	2	RDQ54	C (LVDS)*
K25	PR41A	2	RDQS41	T (LVDS)*	PR54A	2	RDQS54	T (LVDS)*
M20	PR40B	2	RDQ41	C	PR53B	2	RDQ54	C
GND	GNDIO2	-			GNDIO2	-		
M19	PR40A	2	RDQ41	T	PR53A	2	RDQ54	T
L22	PR39B	2	RDQ41	C (LVDS)*	PR52B	2	RDQ54	C (LVDS)*
M22	PR39A	2	RDQ41	T (LVDS)*	PR52A	2	RDQ54	T (LVDS)*
K21	PR38B	2	RDQ41	C	PR51B	2	RDQ54	C
VCCIO	VCCIO2	2			VCCIO2	2		
M21	PR38A	2	RDQ41	T	PR51A	2	RDQ54	T
K24	PR37B	2	RDQ41	C (LVDS)*	PR50B	2	RDQ54	C (LVDS)*
J24	PR37A	2	RDQ41	T (LVDS)*	PR50A	2	RDQ54	T (LVDS)*
GND	GNDIO2	-			GNDIO2	-		
VCCIO	VCCIO2	2			VCCIO2	2		
L20	VCCPLL	2			NC	-		
GND	GNDIO2	-			GNDIO2	-		
J26	PR26B	2	RUM0_SPLLC_FB_A/RDQ24	C	PR39B	2	RUM0_SPLLC_FB_A/RDQ37	C
J25	PR26A	2	RUM0_SPLLT_FB_A/RDQ24	T	PR39A	2	RUM0_SPLLT_FB_A/RDQ37	T
J23	PR25B	2	RUM0_SPLLC_IN_A/RDQ24	C	PR38B	2	RUM0_SPLLC_IN_A/RDQ37	C
K23	PR25A	2	RUM0_SPLLT_IN_A/RDQ24	T	PR38A	2	RUM0_SPLLT_IN_A/RDQ37	T
VCCIO	VCCIO2	2			VCCIO2	2		
H26	PR24B	2	RDQ24	C (LVDS)*	PR37B	2	RDQ37	C (LVDS)*
H25	PR24A	2	RDQS24***	T (LVDS)*	PR37A	2	RDQS37***	T (LVDS)*
H24	PR23B	2	RDQ24	C	PR36B	2	RDQ37	C
GND	GNDIO2	-			GNDIO2	-		
H23	PR23A	2	RDQ24	T	PR36A	2	RDQ37	T
VCCIO	VCCIO2	2			VCCIO2	2		
G26	PR19B	2	RDQ16	C	PR32B	2	RDQ29	C
GND	GNDIO2	-			GNDIO2	-		
G25	PR19A	2	RDQ16	T	PR32A	2	RDQ29	T
F26	PR18B	2	RDQ16	C (LVDS)*	PR31B	2	RDQ29	C (LVDS)*
F25	PR18A	2	RDQ16	T (LVDS)*	PR31A	2	RDQ29	T (LVDS)*
K20	PR17B	2	RDQ16	C	PR30B	2	RDQ29	C
VCCIO	VCCIO2	2			VCCIO2	2		
L19	PR17A	2	RDQ16	T	PR30A	2	RDQ29	T
E26	PR16B	2	RDQ16	C (LVDS)*	PR29B	2	RDQ29	C (LVDS)*
E25	PR16A	2	RDQS16	T (LVDS)*	PR29A	2	RDQS29	T (LVDS)*
GND	GNDIO2	-			GNDIO2	-		
J22	PR15B	2	RDQ16	C	PR28B	2	RDQ29	C
H22	PR15A	2	RDQ16	T	PR28A	2	RDQ29	T

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
C5	PT11B	0		C
D5	PT11A	0		T
E9	PT10B	0		C
G9	PT10A	0		T
GND	GNDIO0	-		
B10	PT9B	0		C
A10	PT9A	0		T
D9	PT8B	0		C
C9	PT8A	0		T
VCCIO	VCCIO0	0		
F9	PT7B	0		C
H9	PT7A	0		T
B9	PT6B	0		C
A9	PT6A	0		T
GND	GNDIO0	-		
E8	PT5B	0		C
G8	PT5A	0		T
A8	PT4B	0		C
B8	PT4A	0		T
VCCIO	VCCIO0	0		
F8	PT3B	0		C
F7	PT3A	0		T
J10	PT2B	0	VREF2_0	C
J9	PT2A	0	VREF1_0	T
AA11	VCC	-		
AA20	VCC	-		
K11	VCC	-		
K21	VCC	-		
K22	VCC	-		
L11	VCC	-		
L12	VCC	-		
L13	VCC	-		
L18	VCC	-		
L19	VCC	-		
L20	VCC	-		
M11	VCC	-		
M20	VCC	-		
N11	VCC	-		
N20	VCC	-		
V11	VCC	-		
V20	VCC	-		
W11	VCC	-		
W20	VCC	-		

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
E27	NC	-		
E28	NC	-		
E29	NC	-		
E3	NC	-		
E30	NC	-		
E4	NC	-		
E5	NC	-		
E6	NC	-		
F25	NC	-		
F5	NC	-		
F6	NC	-		
G6	NC	-		
G7	NC	-		
K10	NC	-		
K9	NC	-		
N27	NC	-		
N4	NC	-		
R1	NC	-		
R2	NC	-		
V27	NC	-		
V4	NC	-		
P22	VCCPLL	-		
P8	VCCPLL	-		
T22	VCCPLL	-		
Y7	VCCPLL	-		

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.

***Due to packaging bond out option, this DQS does not have all the necessary DQ pins bonded out for a full 8-bit data width.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2M50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
U12	PB59B	4	BDQ60	C
GNDIO	GNDIO4	-		
AA12	PB60A	4	BDQS60	T
Y12	PB60B	4	BDQ60	C
V12	PB61A	4	BDQ60	T
W12	PB61B	4	BDQ60	C
AB12	PB62A	4	BDQ60	T
AA13	PB62B	4	BDQ60	C
VCCIO	VCCIO4	4		
T12	PB63A	4	BDQ60	T
U13	PB63B	4	BDQ60	C
V13	PB64A	4	BDQ60	T
T13	PB64B	4	BDQ60	C
GNDIO	GNDIO4	-		
AB13	PB65A	4	BDQ69	T
AB14	PB65B	4	BDQ69	C
U14	PB66A	4	BDQ69	T
T14	PB66B	4	BDQ69	C
AA14	PB67A	4	BDQ69	T
VCCIO	VCCIO4	4		
Y14	PB67B	4	BDQ69	C
W14	PB68A	4	BDQ69	T
V14	PB68B	4	BDQ69	C
AB15	PB69A	4	BDQS69	T
GNDIO	GNDIO4	-		
AA15	PB69B	4	BDQ69	C
V15	PB70A	4	BDQ69	T
U15	PB70B	4	BDQ69	C
AB16	PB71A	4	BDQ69	T
VCCIO	VCCIO4	4		
AA16	PB71B	4	BDQ69	C
AB17	PB72A	4	BDQ69	T
AA17	PB72B	4	BDQ69	C
GNDIO	GNDIO4	-		
W20	CFG2	8		
V20	CFG1	8		
V19	CFG0	8		
V22	PROGRAMN	8		
W22	CCLK	8		
U18	INITN	8		
U22	DONE	8		
GNDIO	GNDIO8	-		
U20	WRITEN***	8		

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2M35E/SE					LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
AF4	PB17B	5	BDQ15	C	PB17B	5	BDQ15	C	
VCCIO	VCCIO5	5			VCCIO5	5			
AF5	PB18A	5	BDQ15	T	PB18A	5	BDQ15	T	
AF6	PB18B	5	BDQ15	C	PB18B	5	BDQ15	C	
Y12	PB19A	5	BDQ15	T	PB19A	5	BDQ15	T	
GNDIO	GNDIO5	-			GNDIO5	-			
AB11	PB19B	5	BDQ15	C	PB19B	5	BDQ15	C	
-	-	-			VCCIO5	5			
-	-	-			GNDIO5	-			
AD7	PB20A	5	BDQ24	T	PB29A	5	BDQ33	T	
AF7	PB20B	5	BDQ24	C	PB29B	5	BDQ33	C	
AD8	PB21A	5	BDQ24	T	PB30A	5	BDQ33	T	
AA12	PB21B	5	BDQ24	C	PB30B	5	BDQ33	C	
AE8	PB22A	5	BDQ24	T	PB31A	5	BDQ33	T	
VCCIO	VCCIO5	5			VCCIO5	5			
AF8	PB22B	5	BDQ24	C	PB31B	5	BDQ33	C	
AD9	PB23A	5	BDQ24	T	PB32A	5	BDQ33	T	
AC10	PB23B	5	BDQ24	C	PB32B	5	BDQ33	C	
AC11	PB24A	5	BDQS24	T	PB33A	5	BDQS33	T	
GNDIO	GNDIO5	-			GNDIO5	-			
AB12	PB24B	5	BDQ24	C	PB33B	5	BDQ33	C	
AD10	PB25A	5	BDQ24	T	PB34A	5	BDQ33	T	
Y13	PB25B	5	BDQ24	C	PB34B	5	BDQ33	C	
AF9	PB26A	5	BDQ24	T	PB35A	5	BDQ33	T	
VCCIO	VCCIO5	5			VCCIO5	5			
AE9	PB26B	5	BDQ24	C	PB35B	5	BDQ33	C	
AF10	PB27A	5	BDQ24	T	PB36A	5	BDQ33	T	
AE10	PB27B	5	BDQ24	C	PB36B	5	BDQ33	C	
AD11	PB28A	5	BDQ24	T	PB37A	5	BDQ33	T	
GNDIO	GNDIO5	-			GNDIO5	-			
AF11	PB28B	5	BDQ24	C	PB37B	5	BDQ33	C	
VCCIO	VCCIO5	5			VCCIO5	5			
GNDIO	GNDIO5	-			GNDIO5	-			
AA13	PB33A	5	BDQS33****	T	PB42A	5	BDQS42****	T	
AB13	PB33B	5	BDQ33	C	PB42B	5	BDQ42	C	
W14	PB34A	5	VREF2_5/BDQ33	T	PB43A	5	VREF2_5/BDQ42	T	
AC12	PB34B	5	VREF1_5/BDQ33	C	PB43B	5	VREF1_5/BDQ42	C	
AF12	PB35A	5	PCLKT5_0/BDQ33	T	PB44A	5	PCLKT5_0/BDQ42	T	
AD12	PB35B	5	PCLKC5_0/BDQ33	C	PB44B	5	PCLKC5_0/BDQ42	C	
VCCIO	VCCIO5	5			VCCIO5	5			
GNDIO	GNDIO5	-			GNDIO5	-			
AC13	PB40A	4	PCLKT4_0/BDQ42	T	PB49A	4	PCLKT4_0/BDQ51	T	
VCCIO	VCCIO4	4			VCCIO4	4			
Y14	PB40B	4	PCLKC4_0/BDQ42	C	PB49B	4	PCLKC4_0/BDQ51	C	
AB20	PB57A	4	BDQ60	T	PB50A	4	VREF2_4/BDQ51	T	
AC14	PB41B	4	VREF1_4/BDQ42	C	PB50B	4	VREF1_4/BDQ51	C	
AB14	PB42A	4	BDQS42****	T	PB51A	4	BDQS51****	T	
GNDIO	GNDIO4	-			GNDIO4	-			

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA
(Cont.)

LFE2M35E/SE					LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
C15	URC_SQ_VCCIB2	12			URC_SQ_VCCIB2	12			
B15	URC_SQ_HDINN2	12		C	URC_SQ_HDINN2	12		C	
C14	URC_SQ_VCCRX2	12			URC_SQ_VCCRX2	12			
A18	URC_SQ_HDOUTP2	12		T	URC_SQ_HDOUTP2	12		T	
C18	URC_SQ_VCCOB2	12			URC_SQ_VCCOB2	12			
B18	URC_SQ_HDOUTN2	12		C	URC_SQ_HDOUTN2	12		C	
C17	URC_SQ_VCCTX2	12			URC_SQ_VCCTX2	12			
B17	URC_SQ_HDOUTN3	12		C	URC_SQ_HDOUTN3	12		C	
A16	URC_SQ_VCCOB3	12			URC_SQ_VCCOB3	12			
A17	URC_SQ_HDOUTP3	12		T	URC_SQ_HDOUTP3	12		T	
C16	URC_SQ_VCCTX3	12			URC_SQ_VCCTX3	12			
B14	URC_SQ_HDINN3	12		C	URC_SQ_HDINN3	12		C	
B13	URC_SQ_VCCIB3	12			URC_SQ_VCCIB3	12			
A14	URC_SQ_HDINP3	12		T	URC_SQ_HDINP3	12		T	
C13	URC_SQ_VCCRX3	12			URC_SQ_VCCRX3	12			
-	-	-			GNDIO1	-			
-	-	-			VCCIO1	1			
E17	PT46B	1		C	PT55B	1		C	
D17	PT46A	1		T	PT55A	1		T	
GNDIO	GNDIO1	-			GNDIO1	-			
F17	PT45B	1		C	PT54B	1		C	
D16	PT45A	1		T	PT54A	1		T	
F19	PT44B	1		C	PT53B	1		C	
F18	PT44A	1		T	PT53A	1		T	
VCCIO	VCCIO1	1			VCCIO1	1			
E16	PT43B	1		C	PT52B	1		C	
D15	PT43A	1		T	PT52A	1		T	
G18	PT42B	1		C	PT51B	1		C	
E15	PT42A	1		T	PT51A	1		T	
GNDIO	GNDIO1	-			GNDIO1	-			
G17	PT41B	1		C	PT50B	1		C	
E14	PT41A	1		T	PT50A	1		T	
D14	PT40B	1		C	PT49B	1		C	
D13	PT40A	1		T	PT49A	1		T	
VCCIO	VCCIO1	1			VCCIO1	1			
F15	PT39B	1	VREF2_1	C	PT48B	1	VREF2_1	C	
E12	PT39A	1	VREF1_1	T	PT48A	1	VREF1_1	T	
H17	PT38B	1	PCLKC1_0	C	PT47B	1	PCLKC1_0	C	
E13	PT38A	1	PCLKT1_0	T	PT47A	1	PCLKT1_0	T	
C12	PT37B	0	PCLKC0_0	C	PT46B	0	PCLKC0_0	C	
GNDIO	GNDIO0	-			GNDIO0	-			
G15	PT37A	0	PCLKT0_0	T	PT46A	0	PCLKT0_0	T	
C11	PT36B	0	VREF2_0	C	PT45B	0	VREF2_0	C	
F14	PT36A	0	VREF1_0	T	PT45A	0	VREF1_0	T	

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M50E/SE					LFE2M70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
L13	VCC	-			VCC	-			
L18	VCC	-			VCC	-			
L19	VCC	-			VCC	-			
M11	VCC	-			VCC	-			
M12	VCC	-			VCC	-			
M13	VCC	-			VCC	-			
M14	VCC	-			VCC	-			
M15	VCC	-			VCC	-			
M16	VCC	-			VCC	-			
M17	VCC	-			VCC	-			
M18	VCC	-			VCC	-			
M19	VCC	-			VCC	-			
M20	VCC	-			VCC	-			
N11	VCC	-			VCC	-			
N12	VCC	-			VCC	-			
N19	VCC	-			VCC	-			
N20	VCC	-			VCC	-			
P12	VCC	-			VCC	-			
P19	VCC	-			VCC	-			
R12	VCC	-			VCC	-			
R19	VCC	-			VCC	-			
T12	VCC	-			VCC	-			
T19	VCC	-			VCC	-			
U12	VCC	-			VCC	-			
U19	VCC	-			VCC	-			
V11	VCC	-			VCC	-			
V12	VCC	-			VCC	-			
V19	VCC	-			VCC	-			
V20	VCC	-			VCC	-			
W11	VCC	-			VCC	-			
W12	VCC	-			VCC	-			
W13	VCC	-			VCC	-			
W14	VCC	-			VCC	-			
W15	VCC	-			VCC	-			
W16	VCC	-			VCC	-			
W17	VCC	-			VCC	-			
W18	VCC	-			VCC	-			
W19	VCC	-			VCC	-			
W20	VCC	-			VCC	-			
Y12	VCC	-			VCC	-			
Y13	VCC	-			VCC	-			
Y18	VCC	-			VCC	-			
Y19	VCC	-			VCC	-			
D14	VCCIO0	0			VCCIO0	0			
E6	VCCIO0	0			VCCIO0	0			
E9	VCCIO0	0			VCCIO0	0			
F12	VCCIO0	0			VCCIO0	0			
K12	VCCIO0	0			VCCIO0	0			

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
U22	GND	-			GND	-		
U23	GND	-			GND	-		
V12	GND	-			GND	-		
V13	GND	-			GND	-		
V15	GND	-			GND	-		
V16	GND	-			GND	-		
V17	GND	-			GND	-		
V18	GND	-			GND	-		
V19	GND	-			GND	-		
V20	GND	-			GND	-		
V22	GND	-			GND	-		
V23	GND	-			GND	-		
W12	GND	-			GND	-		
W13	GND	-			GND	-		
W15	GND	-			GND	-		
W16	GND	-			GND	-		
W17	GND	-			GND	-		
W18	GND	-			GND	-		
W19	GND	-			GND	-		
W20	GND	-			GND	-		
W22	GND	-			GND	-		
W23	GND	-			GND	-		
W26	GND	-			GND	-		
W31	GND	-			GND	-		
W4	GND	-			GND	-		
W9	GND	-			GND	-		
Y16	GND	-			GND	-		
Y17	GND	-			GND	-		
Y18	GND	-			GND	-		
Y19	GND	-			GND	-		
A11	NC	-			NC	-		
A12	NC	-			NC	-		
A23	NC	-			NC	-		
A24	NC	-			NC	-		
AA11	NC	-			NC	-		
AB11	NC	-			NC	-		
AC26	NC	-			NC	-		
AC30	NC	-			NC	-		
AD11	NC	-			NC	-		
AD12	NC	-			NC	-		
AD13	NC	-			NC	-		
AD14	NC	-			NC	-		
AD15	NC	-			NC	-		
AD19	NC	-			NC	-		
AD21	NC	-			NC	-		
AD22	NC	-			NC	-		
AD23	NC	-			NC	-		
AE10	NC	-			NC	-		
AE11	NC	-			NC	-		

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-20E-5Q208I	131	1.2V	-5	PQFP	208	IND	20
LFE2-20E-6Q208I	131	1.2V	-6	PQFP	208	IND	20
LFE2-20E-5F256I	193	1.2V	-5	fpBGA	256	IND	20
LFE2-20E-6F256I	193	1.2V	-6	fpBGA	256	IND	20
LFE2-20E-5F484I	331	1.2V	-5	fpBGA	484	IND	20
LFE2-20E-6F484I	331	1.2V	-6	fpBGA	484	IND	20
LFE2-20E-5F672I	402	1.2V	-5	fpBGA	672	IND	20
LFE2-20E-6F672I	402	1.2V	-6	fpBGA	672	IND	20

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-35E-5F484I	331	1.2V	-5	fpBGA	484	IND	35
LFE2-35E-6F484I	331	1.2V	-6	fpBGA	484	IND	35
LFE2-35E-5F672I	450	1.2V	-5	fpBGA	672	IND	35
LFE2-35E-6F672I	450	1.2V	-6	fpBGA	672	IND	35

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-50E-5F484I	339	1.2V	-5	fpBGA	484	IND	50
LFE2-50E-6F484I	339	1.2V	-6	fpBGA	484	IND	50
LFE2-50E-5F672I	500	1.2V	-5	fpBGA	672	IND	50
LFE2-50E-6F672I	500	1.2V	-6	fpBGA	672	IND	50

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-70E-5F672I	500	1.2V	-5	fpBGA	672	IND	70
LFE2-70E-6F672I	500	1.2V	-6	fpBGA	672	IND	70
LFE2-70E-5F900I	583	1.2V	-5	fpBGA	900	IND	70
LFE2-70E-6F900I	583	1.2V	-6	fpBGA	900	IND	70

Date	Version	Section	Change Summary
June 2013 (cont.)	04.0 (cont.)	DC and Switching Characteristics	sysCLOCK SPLL Timing table – Corrected signal names for t_{RST} parameter.
			LatticeECP2/M sysCONFIG Port Timing Specifications table – added t_{SUMCDI} and t_{HMCDI} parameters.
September 2013	04.1	Architecture	Updated Selectable Master Clock (CCLK) Frequencies during Configuration table.
		DC and Switching Characteristics	Added information on f_{MAXSPI} parameter in LatticeECP2/M sys-CONFIG Port Timing Specifications table.